TOSHIBA PHOTOCOUPLER PHOTO RELAY

TLP3130

MEASUREMENT INSTRUMENTS LOGIC IC TESTERS / MEMORY TESTERS BOARD TESTERS / SCANNERS

The TOSHIBA TLP3130 Mini-flat photorelay is a small-outline photorelay, suitable for surface-mount assembly. The TLP3130 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Its characteristics also include low OFF-state current and low output pin capacitance, enabling it to be used in high-frequency measuring instruments.

Features

- 4 pin SOP (2.54SOP4)
- : 2.1 mm high, 2.54 mm pitch
- 1-Form-A

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- Peak Off-State Voltage : 20 V (MIN.)
- Trigger LED Current : 4 mA (MAX.)
- On-State Current
- : 160 mA (MAX.)

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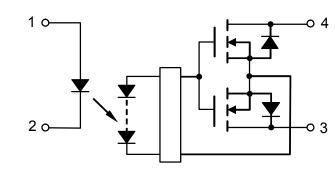
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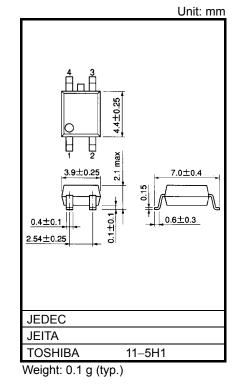
- On-State Resistance Output Capacitance
- Isolation Voltage
- : 8 Ω (MAX.), 5 Ω (TYP.)
- : 2.5 pF (MAX.), 1.0 pF (TYP.)
- : 1500 Vrms (MIN.)



1 : ANODE 2 : CATHODE 3 : DRAIN 4 : DRAIN

Schematic





Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	١ _F	50	mA
Ģ	Forward Current Derating (Ta \ge 25°C)	∆l _F /°C	-0.5	mA/°C
LED	Reverse Voltage	VR	5	V
	Junction Temperature	Tj	125	°C
DETECTOR	Off-State Output Terminal Voltage	V _{OFF}	20	V
	On-State Current	I _{ON}	160	mA
	On-State Current Derating (Ta \ge 25°C)	∆l _{ON} /°C	-1.6	mA/°C
	Junction Temperature	Tj	125	°C
Storage Temperature Range		T _{stg}	-40~125	°C
Operating Temperature Range		T _{opr}	-20~85	°C
Lead	Lead Soldering Temperature (10 s)		260	°C
Isola	tion Voltage (AC, 1 minute, R.H. \leq 60%) (NOTE1)	BVS	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Caution

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

Recommended Operating Conditions

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V _{DD}	_		20	V
Forward Current	١ _F	10		30	mA
On-State Current	I _{ON}	_	—	160	mA
Operating Temperature	T _{opr}	25	—	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I _R	$V_R = 5 V$			10	μA
	Capacitance	CT	V = 0, f = 1 MHz	_	15	_	pF
DETECTOR	Off-State Current	IOFF	V _{OFF} = 20 V, Ta = 50°C			1000	pА
	Capacitance	C _{OFF}	V = 0, f = 100 MHz, t < 1 s	_	1.0	2.5	pF

⁽NOTE 1): Device considered a two-terminal device : Pins 1 and, 2 shorted together, and pins 3 and 4 shorted together.

Coupled Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Trigger LED Current	I _{FT}	I _{ON} = 100 mA	_	_	4	mA
Return LED Current	I _{FC}	I _{OFF} = 10 μA	0.2	0.75	_	mA
On-State Resistance	R _{ON}	I _{ON} = 100 mA, I _F = 5 mA, t < 1 s		5	8	Ω

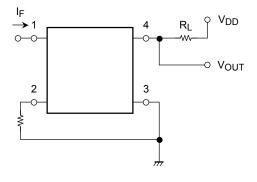
Isolation Characteristics (Ta = 25°C)

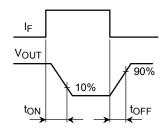
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Capacitance Input to Output	CS	$V_S = 0 V, f = 1 MHz$	—	0.8	_	pF
Isolation Resistance	R _S	$V_{S} = 500 \text{ V}, \text{ R.H.} \le 60\%$	$5 imes 10^{10}$	10 ¹⁴	_	Ω
		AC, 1 minute	1500	_	_	Vrms
Isolation Voltage	BVS	AC, 1 second (in oil)	_	3000	_	VIIIS
		DC, 1 minute (in oil)	—	3000		Vdc

Switching Characteristics (Ta = 25°C)

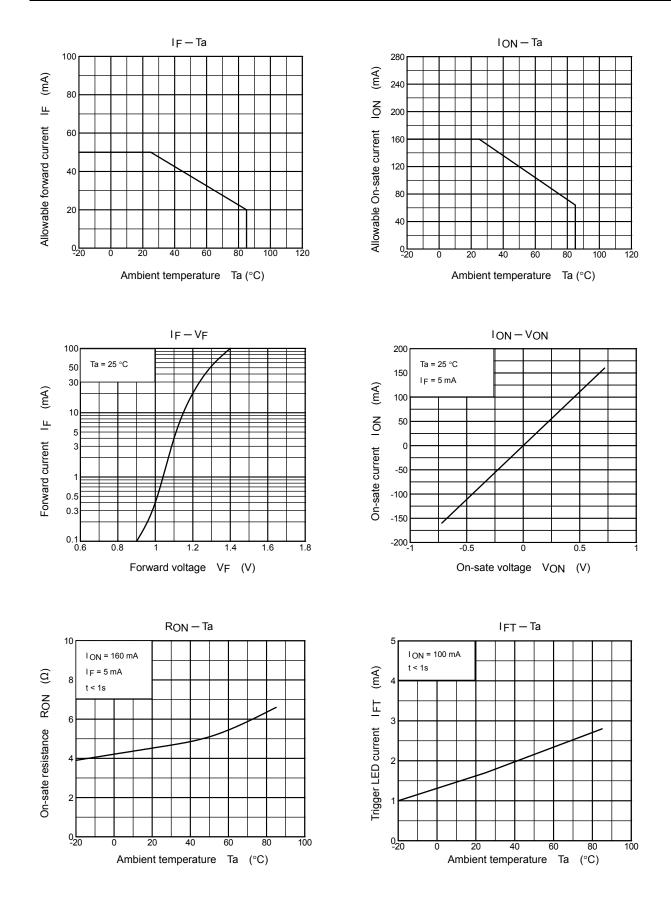
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Turn-on Time		$R_L = 200 \Omega$ (NOTE 2)	_	_	500	
Turn-off Time	tOFF	V _{DD} = 10 V, I _F = 10 mA	—		500	μS

(NOTE 2) : SWITCHING TIME TEST CIRCUIT

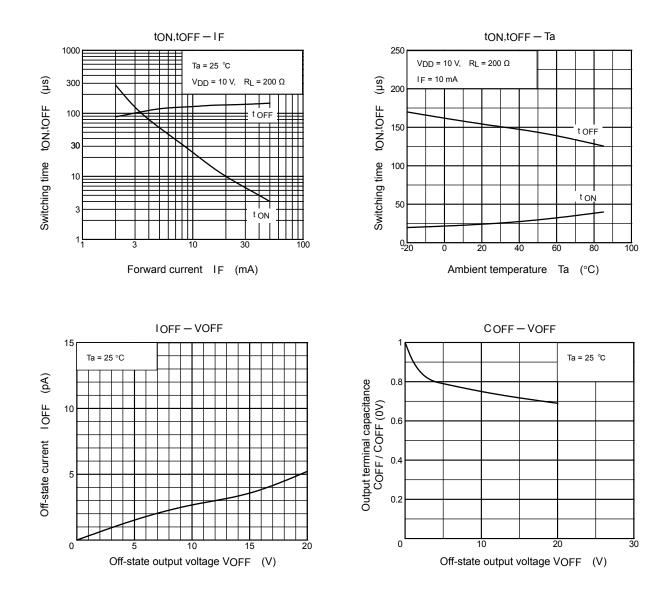




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